**SO-8** 

Top View



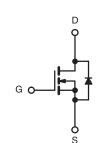
## NCEP0112AS-VB Datasheet

## N-Channel 100-V (D-S) Super Trench Power MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ ) Max.	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
	0.0082 at V <sub>GS</sub> = 10 V	15.5			
100	0.0095 at V <sub>GS</sub> = 7.5 V	14.8	27.9 nC		
	0.0105 at V <sub>GS</sub> = 6.0 V	14.0			

D

D



#### N-Channel MOSFET

#### **FEATURES**

- Super Trench technology Power MOSFET
- Excellent gate charge x Rds (on) product(FOM)
- Very low on-resfistance Rds (on)
- 100 % R<sub>g</sub> and UIS Tested



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- DC/DC Primary Side Switch
- Telecom/Server
- Motor Drive Control
- Synchronous Rectification

Parameter	Symbol	Limit	Unit		
				Oint	
Drain-Source Voltage		V <sub>DS</sub>	100	V	
Gate-Source Voltage		$V_{GS}$	± 20		
	T <sub>C</sub> = 25 °C		15.5		
Continuous Drain Current /T 150 °C)	T <sub>C</sub> = 70 °C		13		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	10.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		7.4 <sup>b, c</sup>	Α Α	
Pulsed Drain Current (t = 300 μs)		I <sub>DM</sub>	70	^	
0 " 0 0 0 0	T <sub>C</sub> = 25 °C		7		
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	- I <sub>S</sub>	3.1 <sup>b, c</sup>		
Single Pulse Avalanche Current	1 01 mll	I <sub>AS</sub>	30		
Avalanche Energy	L = 0.1 mH		45	mJ	
	T <sub>C</sub> = 25 °C		7.8		
Maximum Dawar Dissinction	T <sub>C</sub> = 70 °C		5	١٨/	
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C		2.2 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient <sup>b, d</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	13	16	0/11		

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s
- d. Maximum under steady state conditions is 80 °C/W.

服务热线:400-655-8788

1



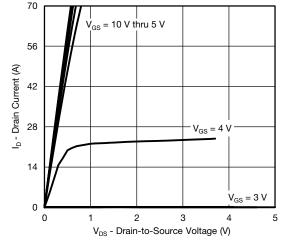
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	-		'			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	100			٧
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 vA		67		mV/°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	- I <sub>D</sub> = 250 μA		- 6.4		
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_{D} = 250 \mu A$	2		3.3	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zawa Oata Walkawa Busin Oawant		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V			1	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C			10	μΑ
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	30			Α
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 15 A		0.0082		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 7.5 \text{ V}, I_D = 12 \text{ A}$		0.0095		Ω
		$V_{GS} = 6.0 \text{ V}, I_D = 10 \text{ A}$	$V_{GS} = 6.0 \text{ V}, I_D = 10 \text{ A}$ 0.010			1
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A		54		S
Dynamic <sup>b</sup>				L		I
Input Capacitance	C <sub>iss</sub>			3410		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		790		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			160		
Total Cata Charge	0	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$	: 10 A	45.6	69	nC
Total Gate Charge	g	Q <sub>g</sub>		27.9	42	
Gate-Source Charge	$Q_gs$	$V_{DS} = 50 \text{ V}, V_{GS} = 6 \text{ V}, I_{D} = 10 \text{ A}$		8.5		
Gate-Drain Charge	$Q_gd$			9.2		
Output Charge	$Q_{oss}$	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$		63	95	
Gate Resistance	$R_g$	f = 1 MHz	0.4	1.3	2.6	Ω
Turn-On Delay Time	t <sub>d(on)</sub>			16	32	
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		11	22	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 7.5 \text{ V}, R_g = 1 \Omega$		35	70	
Fall Time	t <sub>f</sub>			10	20	ns
Turn-On Delay Time	t <sub>d(on)</sub>			14	28	113
Rise Time	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_L = 5 \Omega$		10	20	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		36	70	
Fall Time	t <sub>f</sub>			10	20	
<b>Drain-Source Body Diode Characteristi</b>	cs					
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			7	Α
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				70	^
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = 5 A		0.75	1.1	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			49	95	ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	rr I <sub>F</sub> = 10 A, di/dt = 100 A/μs, T <sub>.I</sub> = 25 °C		58	115	nC
Reverse Recovery Fall Time	t <sub>a</sub>	- 107, απαι = 100 π/μα, 1 <sub>J</sub> = 23 0		21		ne
Reverse Recovery Rise Time	t <sub>b</sub>	b		28		ns

#### Notes:

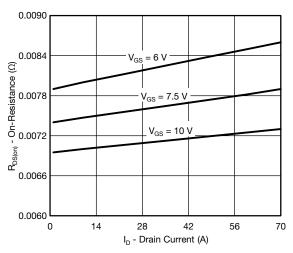
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

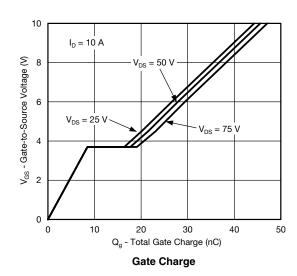


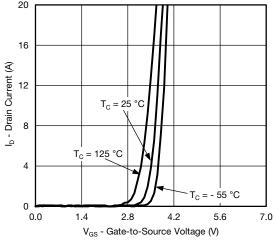


#### **Output Characteristics**

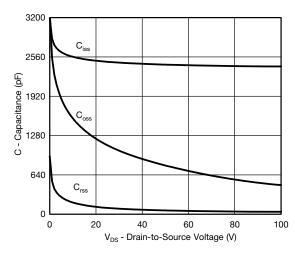


On-Resistance vs. Drain Current

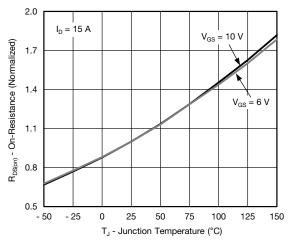




**Transfer Characteristics** 

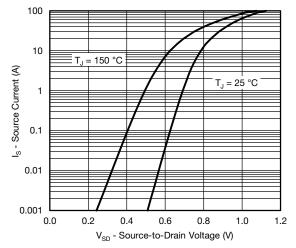


Capacitance

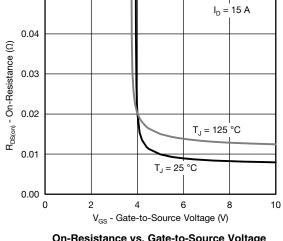


On-Resistance vs. Junction Temperature





Source-Drain Diode Forward Voltage

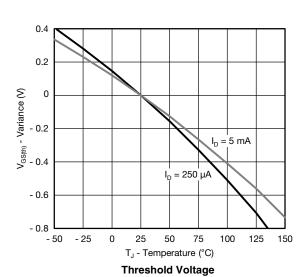


0.05

200

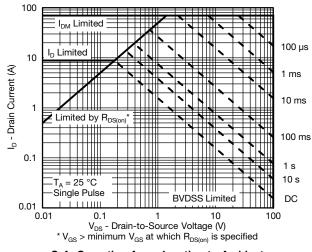
160

On-Resistance vs. Gate-to-Source Voltage



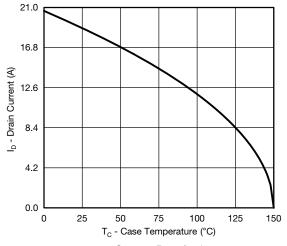
120 Power (W) 80 40 0 0.001 0.1 0.01 10 Time (s)

Single Pulse Power, Junction-to-Ambient

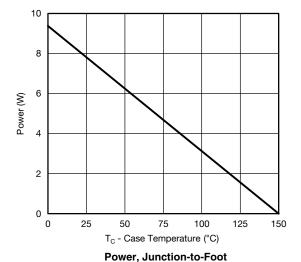


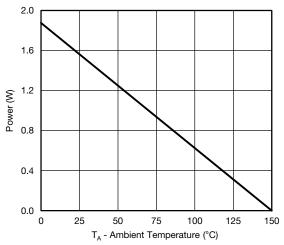
Safe Operating Area, Junction-to-Ambient





#### **Current Derating\***

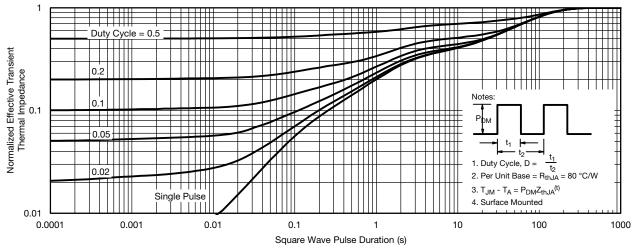




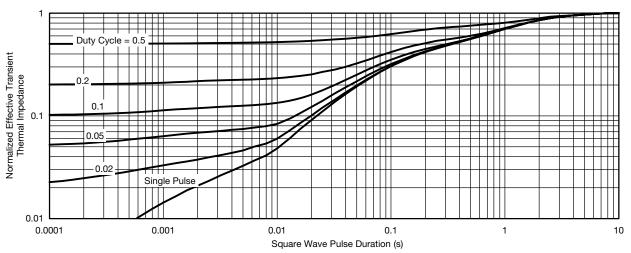
Power, Junction-to-Ambient

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





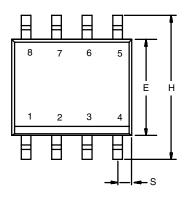
Normalized Thermal Transient Impedance, Junction-to-Ambient

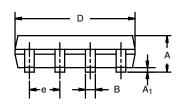


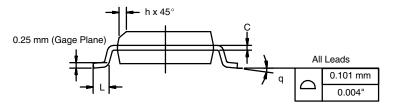
Normalized Thermal Transient Impedance, Junction-to-Foot



SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIMETERS INCHE			HES	
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050	0.050 BSC	
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

8



#### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)



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